

DATA SHEET

ARRAY CHIP RESISTORS

YC/TC

5%, 1%

sizes

YC: 102/104/122/124/162/164/248/324/158T/358L/358T

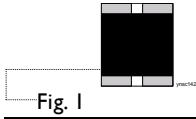
TC: 122/124/164

RoHS compliant



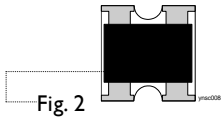
MARKING

YCI02



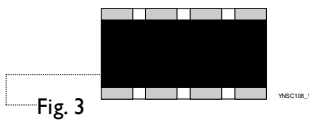
No marking

YCI22



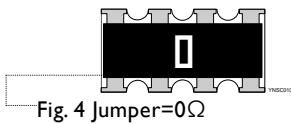
No marking

YCI04



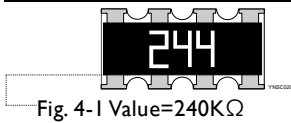
No marking

YCI24 / 162 / 164 / 324



I-Digit marking

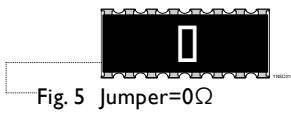
Fig. 4 Jumper=0Ω



E-24 series: 3 digits, 5%
First two digits for significant figure and 3rd digit for number of zeros

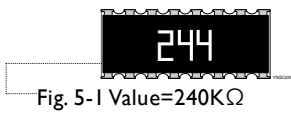
Fig. 4-I Value=240KΩ

YC248



I-Digit marking

Fig. 5 Jumper=0Ω



E-24 series: 3 digits, 5%
First two digits for significant figure and 3rd digit for number of zeros

Fig. 5-I Value=240KΩ

YCI58T/358L/358T

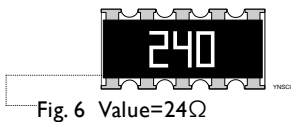


Fig. 6 Value=24Ω

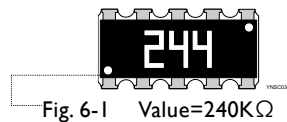
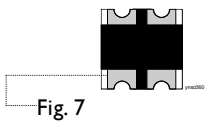


Fig. 6-I Value=240KΩ

E-24 series: 3 digits
First two digits for significant figure and 3rd digit for number of zeros

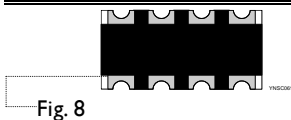
TCI22



No marking

Fig. 7

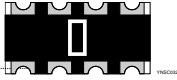
TCI24



No marking

Fig. 8

TCI64



I-Digit marking

Fig. 9 Jumper=0Ω



E-24 series: 3 digits, 5%
First two digits for significant figure and 3rd digit for number of zeros

Fig. 9-I Value=240KΩ

For further marking information, please refer to data sheet “Chip resistors marking”.

CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environment influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Ni-barrier) are added as shown in Fig.10.

OUTLINES

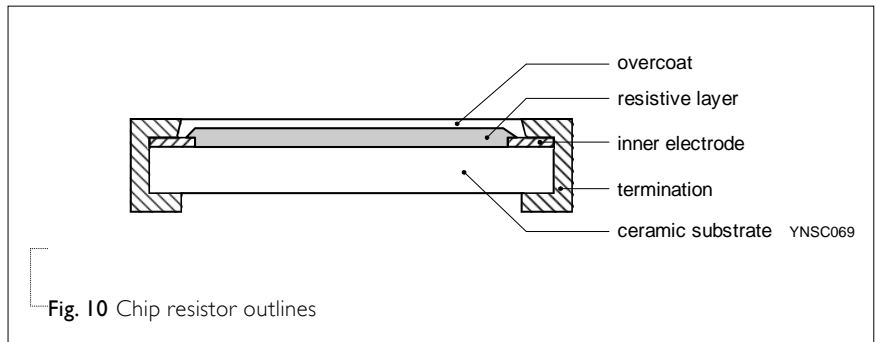
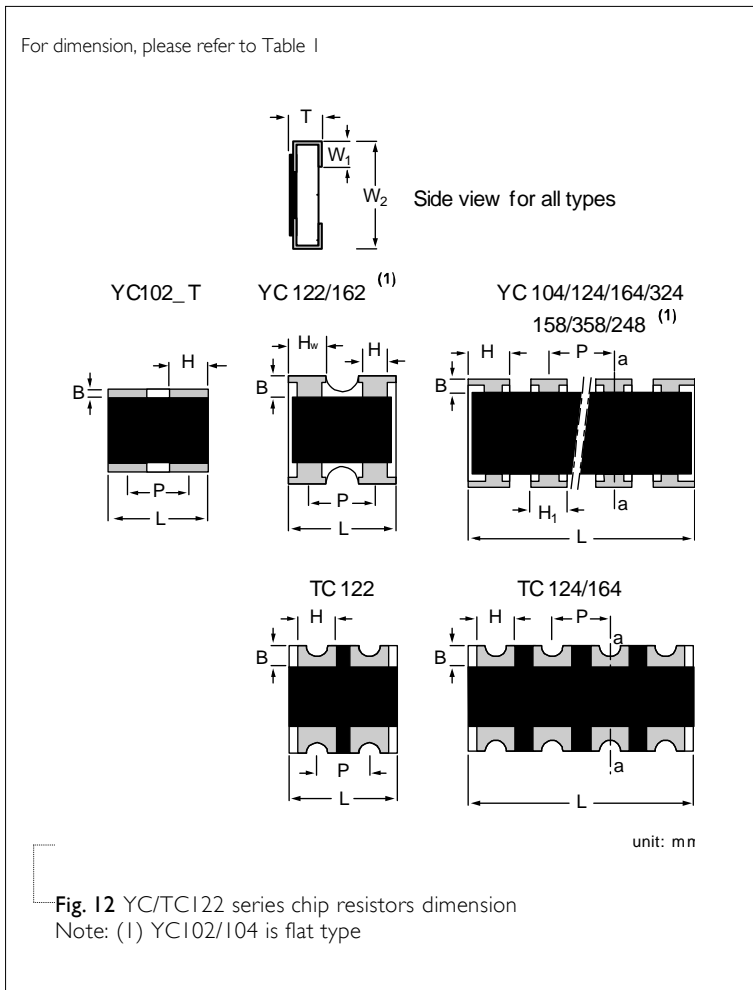
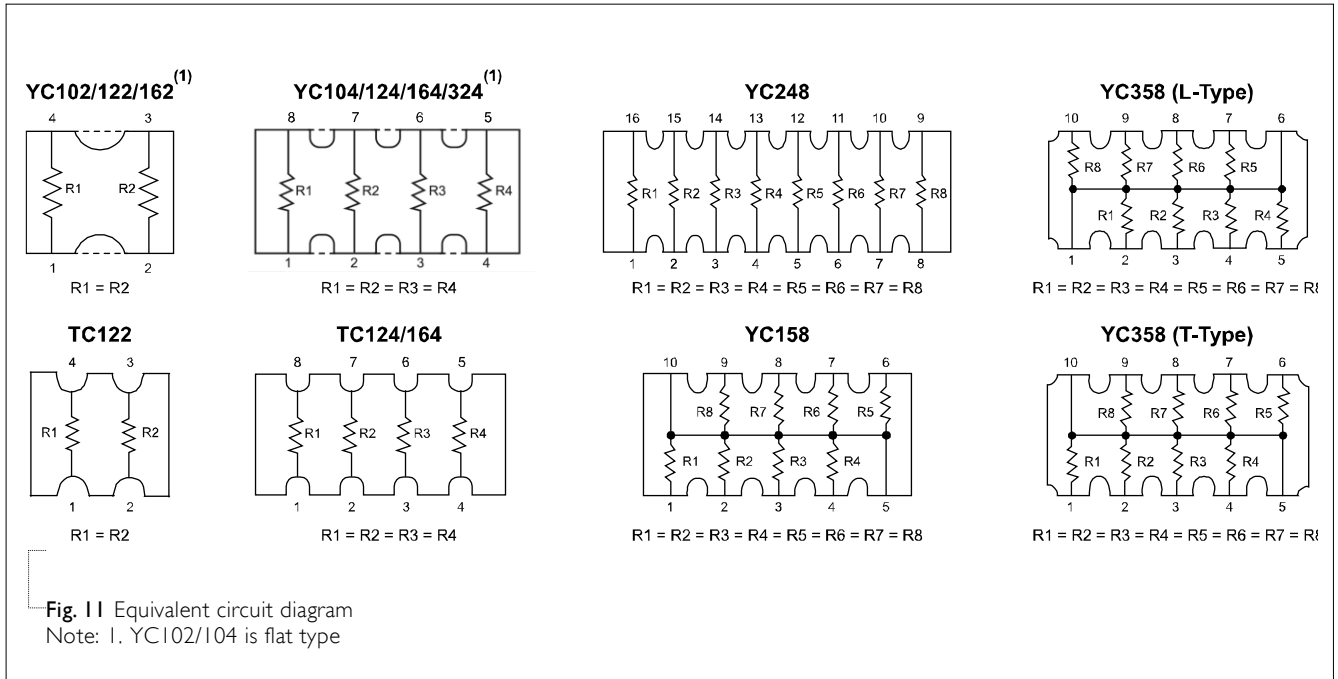


Fig. 10 Chip resistor outlines

SCHEMATIC



DIMENSIONS

Table I

TYPE	H / H _i / H _w	B	P	L	T	W1	W2
YCI02	H: 0.25±0.10	0.15±0.10	0.55±0.10	0.80±0.10	0.35±0.10	0.15±0.10	0.60±0.10
YCI04	H: 0.20±0.10	0.15±0.05	0.40±0.10	1.40±0.10	0.35±0.10	0.15±0.10	0.60±0.10
YCI22	H: 0.210.10 / -0.05 H _w : 0.35±0.10	0.20±0.10	0.67±0.05	1.00±0.10	0.30±0.10	0.25±0.10	1.00±0.10
YCI24	H: 0.40±0.15 H _i : 0.30±0.05	0.20±0.15	0.50±0.05	2.00±0.10	0.45±0.10	0.30±0.15	1.00±0.10
YCI62	H: 0.30±0.10 H _w : 0.65±0.15	0.30±0.10	0.80±0.05	1.60±0.10	0.40±0.10	0.30±0.10	1.60±0.10
YCI64	H: 0.65±0.05 H _i : 0.50±0.15	0.30±0.15	0.80±0.05	3.20±0.15	0.60±0.10	0.30±0.15	1.60±0.15
YC248	H: 0.45±0.05 H _i : 0.30±0.05	0.30±0.15	0.50±0.05	4.00±0.20	0.45±0.10	0.40±0.15	1.60±0.15
YC324	H: 1.10±0.15 H _i : 0.90±0.15	0.50±0.20	1.27±0.05	5.08±0.20	0.60±0.10	0.50±0.15	3.20±0.20
TCI22	H: 0.30±0.05	0.25±0.15	0.50±0.05	1.00±0.10	0.30±0.10	0.25±0.15	1.00±0.10
TCI24	H: 0.30±0.10	0.20±0.10	0.50±0.05	2.00±0.10	0.40±0.10	0.25±0.10	1.00±0.10
TCI64	H: 0.50±0.15	0.30±0.15	0.80±0.05	3.20±0.15	0.60±0.10	0.30±0.15	1.60±0.15
YCI58T	H: 0.45±0.05 H _i : 0.32±0.05	0.30±0.15	0.64±0.05	3.20±0.20	0.60±0.10	0.35±0.15	1.60±0.15
YC358L YC358T	H: 1.10±0.15 H _i : 0.90±0.15	0.50±0.15	1.27±0.05	6.40±0.20	0.60±0.10	0.50±0.15	3.20±0.20

ELECTRICAL CHARACTERISTICS

Table 2

TYPE	POWER P ₇₀	OPERATING TEMP. RANGE	MWV	RCOV	DWV	RESISTANCE RANGE & TOLERANCE	T. C. R.	Jumper criteria (unit: A)
YC102	1/32W	-55°C to +125°C	15V	30V	30V	E24 ±5% 10Ω ≤ R ≤ 1MΩ E24/E96 ±1% 10Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω	±200 ppm/°C	Rated current 0.5 Max. current 1.0
YC104	1/32W	-55°C to +125°C	12.5V	25V	25V	E24 ±5% 10Ω ≤ R ≤ 1MΩ E24/E96 ±1% 10Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω		Rated current 0.5 Max. current 1.0
YC122	1/16W	-55°C to +155°C	50V	100V	100V	E24 ±5% 1Ω ≤ R ≤ 1MΩ E24/E96 ±1% 1Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω		Rated current 0.5 Max. current 1.0
YC124	1/16W	-55°C to +155°C	25V	50V	100V	E24 ±5% 1Ω ≤ R ≤ 1MΩ E24/E96 ±1% 1Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω	1Ω ≤ R ≤ 10Ω ±250 ppm/°C 10Ω < R ≤ 1MΩ ±200 ppm/°C	Rated current 1.0 Max. current 2.0
YC162	1/16W	-55°C to +155°C	50V	100V	100V	E24 ±5% 1Ω ≤ R ≤ 1MΩ E24/E96 ±1% 1Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω		Rated current 1.0 Max. current 2.0
YC164	1/16W	-55°C to +155°C	50V	100V	100V	E24 ±5% 1Ω ≤ R ≤ 1MΩ E24/E96 ±1% 1Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω		Rated current 1.0 Max. current 2.0
YC248	1/16W	-55°C to +155°C	50V	100V	100V	E24 ±5% 10Ω ≤ R ≤ 1MΩ E24/E96 ±1% 10Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω		Rated current 2.0 Max. current 10.0
YC324	1/8W	-55°C to +155°C	200V	500V	500V	E24 ±5% 10Ω ≤ R ≤ 1MΩ E24/E96 ±1% 10Ω ≤ R ≤ 1MΩ		---
TC122	1/16W	-55°C to +125°C	50V	100V	100V	E24 ±5% 10Ω ≤ R ≤ 1MΩ E24/E96 ±1% 10Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω	±200 ppm/°C	Rated current 1.0 Max. current 1.5
TC124	1/16W	-55°C to +125°C	50V	100V	100V	E24 ±5% 10Ω ≤ R ≤ 1MΩ E24/E96 ±1% 10Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω		Rated current 1.0 Max. current 1.5
TC164	1/16W	-55°C to +155°C	50V	100V	100V	E24 ±5% 10Ω ≤ R ≤ 1MΩ E24/E96 ±1% 10Ω ≤ R ≤ 1MΩ Jumper < 0.05Ω		Rated current 1.0 Max. current 2.0
YC158T	1/16W	-55°C to +155°C	25V	50V	50V	E24 ±5% 10Ω ≤ R ≤ 100KΩ		---
YC358L YC358T	1/16W	-55°C to +155°C	50V	100V	100V	E24 ±5% 10Ω ≤ R ≤ 330KΩ		---

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please refer to data sheet “Chip resistors mounting”.

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	PACKING STYLE	YC102/ 104	YC/TC 122	YC/TC 124	YC162	YC/TC 164	YC248	YC324	YC158T	YC358L YC358T
Paper taping reel (R)	7" (178mm)	10,000	10,000	10,000	5,000	5,000	5,000	---	5,000	---
	13" (254mm)	50,000	50,000	40,000	---	20,000	---	---	20,000	---
Embossed taping reel (K)	7" (178mm)	---	---	---	---	---	4,000	4,000	---	4,000

NOTE

1. For tape and reel specification/dimensions, please refer to data sheet “Chip resistors packing”.

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

YC102/104, TC122/124 Range:

-55°C to +125°C (Fig.13)

YC122/124/162/164/248/324/158T/358L/358T, TC164

Range:

-55°C to +155°C(Fig.14)

POWER RATING

Each type rated power at 70°C

YC102/104 = 1/32 W

YC122/124/162/164/248/158T/358L/358T = 1/16 W

YC324 = 1/8 W

TC122/124/164 = 1/16 W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

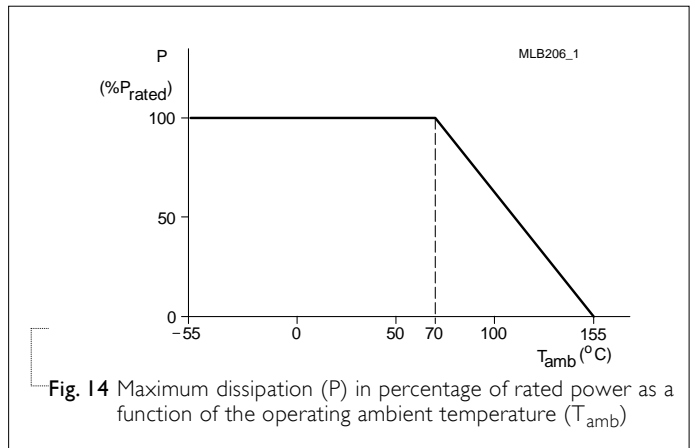
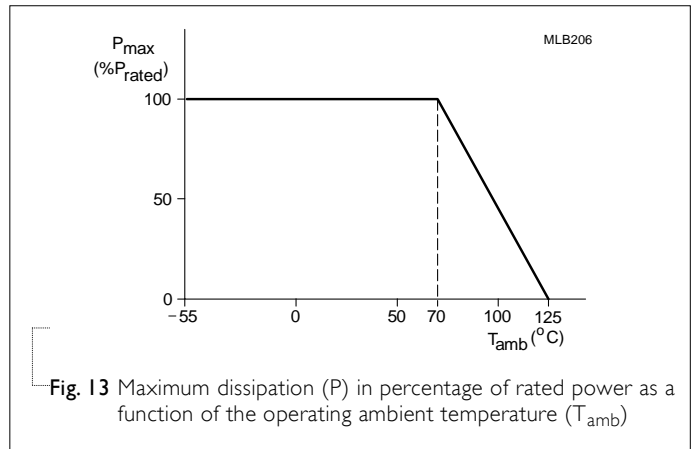
or max. working voltage whichever is less

Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)



TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Life/ Operational Life/ Endurance	MIL-STD-202-method 108 IEC 60115-1 7.1	1,000 hours at 70±5 °C applied RCWV 1.5 hours on, 0.5 hour off, still air required	±(2%+0.05 Ω) <100 mΩ for Jumper
High Temperature Exposure/ Endurance at Upper Category Temperature	MIL-STD-202-method 108	1,000 hours at maximum operating temperature depending on specification, unpowered	±(1%+0.05 Ω) <50 mΩ for Jumper
Moisture Resistance	MIL-STD-202-method 106 IEC 60115-1 4.24.2	Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered Parts mounted on test-boards, without condensation on parts Measurement at 24±2 hours after test conclusion	±(2%+0.05 Ω) <100 mΩ for Jumper
Thermal Shock	MIL-STD-202-method 107	-55/+125 °C Note: Number of cycles required is 300. Devices mounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	±(1%+0.05 Ω) <50 mΩ for Jumper
Short Time Overload	IEC60115-1 8.1	2.5 times RCWV or maximum overload voltage whichever is less for 5 sec at room temperature	±(2%+0.05 Ω) <50 mΩ for Jumper No visible damage
Board Flex/ Bending	IEC60115-1 9.8	Device mounted on PCB test board as described, only 1 board bending required 3 mm bending Bending time: 60±5 seconds Ohmic value checked during bending	±(1%+0.05 Ω) <50 mΩ for Jumper No visible damage

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability - Wetting	J-STD-002 test	Electrical Test not required Magnification 50X SMD conditions: 1 st step: aging 4 hours at 155 °C dry heat 2 nd step: method B1, leadfree solder bath at 245±3 °C Dipping time: 3±0.5 seconds	Well tinned (≥95% covered) No visible damage
- Leaching	J-STD-002 test	Leadfree solder, 260 °C, 30 seconds immersion time	No visible damage
- Resistance to Soldering Heat	MIL-STD-202-method 210	Condition B, no pre-heat of samples Leadfree solder, 260 °C, 10 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(1%+0.05 Ω) <50 mΩ for Jumper No visible damage
Biased Humidity	AEC-Q200 Test 7 MIL-STD-202-Method 103	1,000 hours; 85 °C / 85% RH 10% of operating power Measurement at 24± 4 hours after test conclusion.	± (5.0%+0.05 Ω)

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 9	Feb.19, 2019	-	- Update H dimension for YC124
Version 8	Dec. 24, 2018	-	- Update AEC-Q200 qualified
Version 7	Aug. 22, 2017	-	- Correct the typo for YC158T/358L/358T, Marking, "240" is 24ohm
Version 6	Jun. 1, 2017	-	- Update ordering information for networks YC158T/YC358L/YC358T
Version 5	Feb. 14, 2017	-	- Update YC158 and 358 part number to YC158T , YC358L and YC358T
Version 4	Dec. 22, 2016	-	- Delete YC102 default code L type
Version 3	Apr. 29, 2016	-	- Update YC series and TC164 dimension
Version 2	Dec. 11, 2015	-	- Update Operating Temperature
Version 1	Feb. 04, 2015	-	- Update YC102 to flat type
Version 0	Nov. 14, 2014	-	- First issue of this specification

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